Dear Valued Customer

Issue date:

Teruhiro Koshiba
General Manager

LowVoltage Device Division
Si Power Device Business Unit
ROHM Co., Ltd.

Notification of Product/Process Change

Doc. No.: 302600E

(TG131)

This letter intends as a formal notification of change to products which are currently supplied by ROHM Co., Ltd.

ROHM Co., Ltd. requires customers to provide acknowledgment of the receipt of this notification within 30 days from the date of this notice. Lack of acknowledgment of this notice within 30 days is considered as acceptance of the change.

After acknowledgement of the customer, lack of additional response within 90 day period constitutes acceptance of the change according to JEDEC Standard J-STD-046.

Your understanding and cooperation would be highly appreciated.

Issue Date: September 1, 2026

Title of change	Si Power Transistors HUML6 package Assembly Site Change.(OSAT→In-house)		
Affected product(s)	Manufacturer part number	Customer part number	
	Refer attached sheet		
Detailed description of change	Before	After	
	Backend Manufacturing Site : OSAT [HANA SEMICONDUCTOR (AYUTTHAYA) Co., Ltd.]	Backend Manufacturing Site : ROHM [ROHM Integrated Systems (Thailand) Co., Ltd.]	
Reason for change	The production site will be consolidated into ROHM's Thailand manufacturing facility as part of a production footprint optimization initiative.		
Anticipated impact on quality	The implemented change does not affect product quality.		
Identification of change	Identification can be achieved through marking-based traceability.		
Planned first ship date	September 1, 2026	Sample available schedule :	September 1, 2026
Comments	If you need existing products, please place your orders for the required quantities by September 30, 2027. Following the consolidated production, we would appreciate your cooperation in receiving the products in a single shipment.		
Supplier contact	Please contact the local ROHM sales office or the authorized distributor.		
Notes			